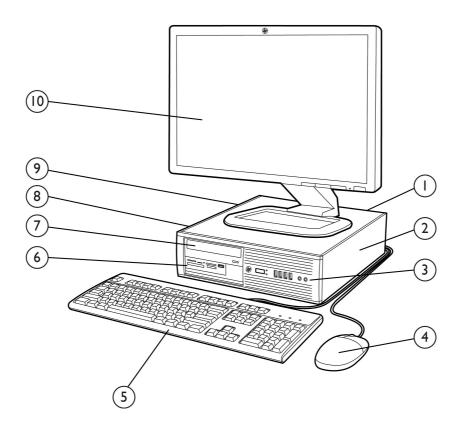
Overview

HP Compaq 4000 Pro Small Form Factor Business PC



- Rear I/O includes (4) USB 2.0 ports, serial port, PS/2 mouse and keyboard ports, RJ-45 network interface, VGA and DVI-D video interfaces, and audio in/out jacks
- 2 Low profile expansion slots include (2) PCI slots, (1) PCI Express x1 slot, and (1) PCI Express x16 graphics slot
- 3 Front I/O includes (4) USB 2.0 ports, dedicated headphone output, and a microphone jack
- 4 HP Optical Mouse
- 5 HP Keyboard
- 6 3.5" external drive bay supporting a media card reader
- 7 5.25" external drive bay supporting an optical disk drive
- 8 3.5" internal drive bay supporting a hard disk drive
- 9 240W standard efficiency or 85% high efficiency Power Supply
- 10 HP Monitor (sold separately)



Overview

At A Glance

- Designed for long-term deployment within commercial and public sector organizations
- BIOS developed and engineered by HP for better security, manageability and software image stability
- Intel® B43 Express chipset featuring integrated GMA 4500 integrated graphics
- Intel® 82567V Gigabit LAN Networking Controller
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Integrated dual independent monitor support via a VGA and DVI-D video interface
- Standard efficiency, high voltage protection or 85% high efficiency energy saving power supplies available (offering will vary by geographic region)
- ENERGY STAR qualified models available (dependent upon the desired configuration and geographic region)
- Guaranteed lengthy purchase lifecycles and image stability
- Created using industry leading Design for Environment standards
- Tailored HP Factory Express deployment and lifecycle services available (http://h71028.www7.hp.com/enterprise/cache/97688-0-0-225-121.aspx)
- Protected by HP Services, including standard warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)



Standard Features and Configurable Components (availability may vary by country)

Operating Systems

Preinstalled Genuine Windows Vista Business (32-bit)¹

Genuine Windows Vista Home Basic¹
Genuine Windows 7 Starter Edition (32-bit)

Genuine Windows 7 Home Basic Edition (32-bit)²

Genuine Windows 7 Home Premium Edition (32-bit or 64-bit)² Genuine Windows 7 Professional Edition (32-bit or 64-bit)² Genuine Windows 7 Ultimate Edition (32-bit or 64-bit)²

Red Flag Linux (available only in China)³

FreeDOS

Supported Genuine Windows XP Professional Edition

Genuine Windows Vista Enterprise Edition¹ Genuine Windows 7 Enterprise Edition²

- HP 22-in-1 media card reader
- HP 802.11b/g/n wireless NIC
- HP Serial port adapter
- HP Parallel port adapter



¹ Certain Windows Vista product features require advanced or additional hardware. See www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: www.windowsvista.com/upgradeadvisor

² System may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

³ The following features are not supported on Linux certified systems:

Standard Features and Configurable Components (availability may vary by country)

Value Added Software (included with select models; not included when configured with FreeDOS)

Computer Setup Utility

HP Connect Solutions

Norton Internet Security 2011*

Roxio Creator Business

HP Power Assistant

PC Network Clone

PDF Complete Corporate Edition

Corel WinDVD

Microsoft Office 2010 preloaded (purchase of a Product Key

required to activate a full Office 2010 suite)**

Mozilla Firefox for HP Virtual Solutions

HP Virtual Rooms

Huddle

HP Client Management Solutions (available for free download from the Internet)

http://www.hp.com/go/easydeploy)

HP Client Automation Starter*
HP SoftPaq Download Manager

HP Client Catalog for Microsoft SMS HP Systems Software Manager

Value Added Services and Features

HP Stable Platform Program

HP Product Change Notification Program

Factory Express Deployment and Lifecycle Services

Business-to-Business Portals

Service and Support

On-site warranty and service¹: This limited warranty and service offering delivers parts, labor and on-site repair for terms up to 5 years. Response time is next business day² and includes free telephone support³ 24 x 7. Some countries/regions do not offer one year onsite and labor.

- ¹ Terms and conditions may vary by country. Certain restrictions and exclusions apply.
- ² On-site services may be provided pursuant to a service contract between HP and an authorized HP third party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- ³ Technical telephone support applies only to HP configured, HP and HP qualified third party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

Chipset

Intel B43 Express with Intel GMA 4500 Graphics



^{* 60} day trial period for Norton Internet Security 2011 software. Internet access required to receive updates. First update included. Subscription required for updates thereafter.

^{**} Microsoft Office 2010 Preloaded includes reduced functionality versions of Word and Excel. Purchase of Product Key required to activate full Office 2010 suite available at participating resellers/retailers and http://www.office.com.

^{*} Available from your HP Sales Representative or HP Channel Partner

Standard Features and Configurable Components (availability may vary by country)

Processor

Intel Celeron Processors

Intel Celeron E3400 Processor 2.60 GHz, 1M L2 cache, 800 MHz FSB

Intel Celeron E3500 Processor 2.70 GHz, 1M L2 cache, 800 MHz FSB

Intel Pentium Processors:

Intel Pentium E5800 Processor 3.20 GHz, 2M L2 cache, 800 MHz FSB

<u>Intel Pentium E6700 Processor</u> 3.20 GHz, 2M L2 cache, 1066 MHz FSB

<u>Intel Pentium E6800 Processor</u> 3.33 GHz, 2M L2 cache, 1066 MHz FSB

Intel Core 2 Duo Processors

Intel Core 2 Duo E7500 Processor 2.93 GHz, 3M L2 cache, 1066 MHz FSB

Intel Core 2 Duo E7600 Processor 3.06 GHz, 3M L2 cache, 1066 MHz FSB

Intel Core 2 Duo E8400 Processor 3.0 GHz, 6M L2 cache, 1333 MHz FSB

Intel Core 2 Duo E8500 Processor

3.16 GHz, 6M L2 cache, 1333 MHz FSB

Intel Core 2 Duo E8600 Processor 3.33 GHz, 6M L2 cache, 1333 MHz FSB

Intel Core 2 Quad Processors

Intel Core 2 Quad Q9505s Processor 2.83 GHz, 6M L2 cache, 1333 MHz FSB, 65W TDP

Intel Core 2 Quad Q9550s Processor 2.83 GHz, 12M L2 cache, 1333 MHz FSB, 65W TDP



Standard Features and Configurable Components (availability may vary by country)

DDR3 Synchronous DRAM NON-ECC System Memory

Memory upgrades are accomplished by adding single or multiple DIMMs of the same or varied sizes. This chart does not represent all possible memory configurations. The HP Compaq 4000 Pro Series PC supports non-ECC DDR3 memory up to a maximum data rate of 1066 MHz.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

Memory Configurations

Maximum Memory

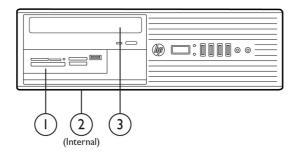
Supports up to 8 GB of DDR3 SDRAM using DIMM modules. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE:

For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

| Total Memory | Slot | | | | |
|--------------|-----------|-----------|--|--|--|
| | Channel A | Channel B | | | |
| | 1 (black) | 2 (white) | | | |
| 2 GB | 2 GB | | | | |
| 4 GB | 2 GB | 2 GB | | | |
| 8 GB | 4 GB | 4 GB | | | |

Data Storage Drives



| Storage Drive Support | | | | | | | |
|-----------------------|-------------------|-----|-----------------|--|--|--|--|
| | Media Card Reader | ODD | Hard Disk Drive | | | | |
| Quantity Supported | 1 | 1 | 1 | | | | |
| Position | 1 | 2 | 3 | | | | |
| | | | | | | | |



Standard Features and Configurable Components (availability may vary by country)

Hard Disk Drives

HP 250-GB Hard Disk Drive 7,200 rpm, NCQ, Smart IV

HP 320-GB Hard Disk Drive

7,200 rpm, NCQ, Smart IV

HP 500-GB Hard Disk Drive

7,200 rpm, NCQ, Smart IV

HP 1 TB Hard Disk Drive

7,200 rpm, NCQ, Smart IV

Optical Disc Drives

HP DVD-ROM Drive

HP SuperMulti Writer Drive 1,2

HP Blu-ray Writer Drive 1,2

¹For playing DVDs, Corel WinDVD 8

²For writing CDs and DVDs, Roxio Business Creator 10

Media Card Readers

HP Media Card Reader (22-in-1)

Security Solutions and Capabilities

Stringent Security (via BIOS) This setting is defaulted to disable, but when enabled, the PW jumper will not clear the BIOS preboot authentication passwords.

SATA Port Disablement (via BIOS)

Drive Lock

Serial, Parallel, USB enable/disable (via BIOS)

Optional USB Port Disable at factory (user configurable via BIOS)

Removable Media Write/Boot Control

Power-On Password (via BIOS)

Setup Password (via BIOS)

HP Chassis Security Kit

Support for chassis padlocks and cable lock devices

Network Interface Connections

Intel® 82567V GbE Network Connection (integrated)

HP 802.11 b/g/n Wireless NIC (PCle x1 card)



Standard Features and Configurable Components (availability may vary by country)

Video Graphics

Intel® Graphics Media Accelerator 4500 (integrated)

NVIDIA NVS 300 512MB graphics card

ATI Radeon HD 4550 512MB graphics card

Multi-Media

High Definition Audio with Realtek ALC261 codec (all ports are stereo)

Microphone/Headphone front ports (standard)

Line-out and Line-In rear Ports (standard)

Multi-streaming capable (standard)

Internal Speaker (standard)

HP Thin USB Powered Speakers (optional)

Note: The audio ports/jacks provided by all of our systems are 3.5mm in diameter. This would include both the front jacks and rear jacks, for audio in/out, mic in and headphone out.

Input/Output Devices

HP PS/2 Standard Keyboard

HP USB Standard Keyboard

HP USB Smart Card (CCID) Keyboard

HP USB Mini Keyboard

HP USB and PS/2 Washable Keyboard

HP PS/2 Optical Mouse

HP USB Optical Mouse

HP USB Laser Mouse

HP USB and PS/2 Washable Mouse

Miscellaneous Devices and Configurations

Serial Port Adapter (RS-232 compatible)

Parallel Port Adapter

PC Tower Stand

Non-Standard HDD Disk Partitioning (50%/50%)



After-Market Options (availability may vary by region)

| Communication Devices | Part Number |
|--|-------------|
| HP Wireless 802.11 b/g/n NIC (PCIe x1 card) | FH971AA |
| Broadcom NetXtreme GbE Ethernet Plus NIC (PCle x1 card) | FS215AA |
| Graphics Gra | Part Number |
| NVIDIA NVS 300 PCle x1 512MB card | BV456AA |
| NVIDIA NVS 300 PCle x16 512MB card | BV457AA |
| ATI Radeon HD 4550 (512MB DH) PCIe x16 Card | AT042AA |
| HP DMS59 DVI Dual-head Connector Cable | DL139A |
| HP DVI Cable Kit | DL198AT |
| lard Disk Drives | Part Number |
| HP 250GB Hard Disk Drive | TBA |
| HP 320GB Hard Disk Drive | ТВА |
| HP 500GB Hard Disk Drive | TBA |
| HP 1TB Hard Disk Drive | TBA |
| nput/Output Devices | Part Number |
| HP PS/2 Standard Keyboard | DT527A |
| HP USB Standard Keyboard | DT528A |
| HP USB Mini Keyboard | AS601AA |
| HP USB Gray Standard Keyboard | DT529A |
| HP USB Smart Card (CCID) Keyboard | BV813AA |
| HP USB Keyboard and Mouse Kit | RC465AA |
| HP USB & PS/2 Washable Keyboard | VF097AT |
| HP USB & PS/2 Washable Mouse | BM866AA |
| HP USB & PS/2 Washable Keyboard and Mouse Kit | BU207AA |
| HP PS/2 Optical Mouse | EY703AA |
| HP USB Optical Mouse | DC172AT |
| HP USB Laser Mouse | GW405AT |
| HP USB Travel Mouse | RH304AA |
| HP Mouse Pad | AT485AA |



| After-Market Options (availability may vary by region) | |
|--|------------|
| HP 2.4GHz Wireless Keyboard and Mouse | NB896AA |
| System Memory | Part Numbe |
| HP 1 GB DDR3 DIMM | AT023AA |
| HP 2 GB DDR3 DIMM | AT024AA |
| HP 4 GB DDR3 DIMM | VH638AA |
| Multimedia Devices | Part Numbe |
| HP Thin USB Powered Speakers | KK912AA |
| HP DVD-ROM Drive | AR629AA |
| HP SuperMulti DVD Writer Drive | AR630AA |
| HP Blu-ray Writer Drive | AR482AA |
| Removable Media Storage | Part Numbe |
| HP External USB 1.44MB Floppy Drive | DC141B |
| HP Media Card Reader (22-in-1) | AR941AA |
| Security Devices | Part Numbe |
| HP Business PC Security Lock | PV606AA |
| HP SFF Wall Mount/Security Sleeve | VN570AA |
| HP Chassis Security Kit | AR639AA |
| HP Keyed Security Kit | BV411AA |
| HP Client Automation Software | Part Numbe |
| HP Client Automation – Standard Edition (single seat) | T3488AA |
| HP Client Automation – Standard Edition (10 seats) | TA599AA |
| HP Client Automation – Standard Edition (100 seats) | TA600AA |
| HP Client Automation – Standard Edition (500 seats) | TA601AA |
| HP Client Automation – Standard Edition (1,000 seats) | Т3489АА |
| Stands and Accessories | Part Numbe |
| HP SFF Tower Stand | VN569AA |
| HP Serial Port Adapter (RS-232 compatible) | PA716A |
| HP Parallel Port Adapter | KD061AA |



Technical Specifications

Weights and

Dimensions

Chassis 3.95 x 13.30 x 14.9 in (H x W x D) 100 x 338 x 378.5 mm

System Volume 782.77 cu in

12.83 L

Tower Stand 1.12 x 7.01 x 7.87 in (H x W x D) 28.5 x 178 x 200 mm

Packaging 9.00 x 19.68 x 23.38 in (H x W x D) 228.6 x 499.9 x 593.85 mm

System Weight 16.72 lb

7.6 kg

Shipping Weight 17.86 lb

8.1 kg

Max Supported Weight 77 lb (desktop orientation) 35 kg

I/O Ports

Small Form Factor

Small Form Factor

USB 2.0 Front – four (4) ports

Rear – four (4) ports

Serial one RS-232 compatible port standard

second port available optionally

Parallel one port available as an option

PS/2 color coded support for keyboard (purple) and mouse (green)

Video VGA and DVI-D provide integrated dual independent monitor support

Audio Front – microphone & headphone

Rear - line in & line out

NIC RJ-45 port accesses the integrated Intel® network interface controller

Slots Small Form Factor

Type and quantity (2) 5-volt PCI

(1) PCle x1; 10W max. power (1) PCle x16; 25W max. power

Slot specifications Low profile – 2.5"

Length: 6.6" 25W maximum

Bays Small Form Factor

3.5" external

1 bay available for optional Media Card Reader
5.25" external

1 bay - 8.19" depth for optional optical disc drive

Internal HDD Bay 1 bay for 3.5" hard disk drive



Technical Specifications

Controller Small Form Factor

Hard Drive Controller Serial ATA (SATA) 2.0

Supports up to 3.0-GB/s

SATA Interfaces (2) Total

Host SATA Controller Advanced Host Controller Interface (AHCI) Revision 1.2. The specification includes a

description of the hardware/software interface between system software and the host

controller hardware.

Unit Environment and Operating Conditions

General Unit Operating Guidelines

Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is
operated within the specified operating range.

- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)*

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Altitude Operating: 10,000 ft (3048 m)
unpressurized) Non-operating: 30,000 ft (9144 m)

*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.



Technical Specifications

Power Supply

| | • | | | | | | |
|--------------------------------------|----------------|---|-----------------------|---|------------------|--|--|
| | | Standard High E | | ciency | High Voltage | | |
| Efficiency R | ating | 70% @ 100% load | 82/85/82 20/50/100 | _ | 70% @ =100% load | | |
| Max Power | Rating | 240W | | | | | |
| Power Facto (PFC) | or Correcting | Active | | | | | |
| Maximum | 115 VAC: | 90 – 140 VAC | | | | | |
| Voltage Range | 220VAC: | 180 – 264 VAC | | | | | |
| Nominal | 115 VAC: | 100 – 127 VAC | | | | | |
| Voltage Range | 220VAC: | 200 – 240 VAC | | | | | |
| Rated Line I | Frequency | 50/60 Hz | | | | | |
| Operating I Range | Line Frequency | 47 – 63 Hz | | | | | |
| Rated Input | Current | 4A | | | | | |
| Maximum c leakage Cu (NFPA 99) | | 275 μΑ | | | | | |
| Power Supp | oly Fan | 92mm variable speed | | | | | |
| Surge Protection | | Standard/High Efficiency | | High Voltage | | | |
| De-Rating F | actor actor | <95% for all continuous condition | าร | ?100% for all continuous conditions | | | |
| Test Conditions | | 132 Vac to 155 Vac for 500 msec and back to 132 Vac | | 300Vac for 30 minutes, followed by two 410Vac/1sec surges @ 0.1Hz repetition rate | | | |

• 264 Vac to 293 Vac for 500 msec and back to 264 Vac. Repeat 10 times with 10

second delay.



Technical Specifications

ROM BIOS Information

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Compaq 4000 Pro PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so
 component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any
 enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (Flashbin), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made
 to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Elite models
 use ACPI to provide power conservation features.
- Support for Self Encrypting Hard Drives (SED)
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W in S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

Other Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
 Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- System Management BIOS v2.6
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button



Technical Specifications

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED explanation table:
 - O Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, bootblock recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- System/Emergency ROM
- Flash ROM
- CMOS battery holder for easy replacement
- Flash recovery with video configuration record software
- 5 Aux power LED on system PCA
- Processor ZIF socket for easy upgrade
- Over-temp warning on screen (requires IM agents)
- Clear password jumper
- DIMM connectors for easy upgrade
- Clear CMOS button
- NIC LEDs (integrated) (green & amber)
- Dual color power and HD LED to indicate normal operations and fault conditions
- Color coordinated cables and connectors
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Green pull tabs, and quick release latches for easy identification

Additional Features Description

ASF 2.0 support (Alert Standard Format)

Industry-standard specification for network alerting in operating system-absent environments

Computrace Computrace agent support standard

Towerable Orientation Product can be oriented as either a desktop or a tower. When oriented as a tower it is

recommended to use the optional HP SFF Tower Stand.

Implementation of the industry standard ATA Security feature set. When enabled, it Drive Lock prevents software access to user data on the drive until one or two user-defined

passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self test. It scans critical physical components and every sector

of the hard drive for physical faults and then reports any faults to the user



Technical Specifications

Drive Protection System

Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology) Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted

SMART I – Drive Failure Prediction

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count

SMART II – Off-Line Data Collection

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure

SMART III – Off-Line Read Scanning with Defect Reallocation

IOEDC: I/O Error Detection Circuitry

SMART IV – End-to-End CRC for hard drives

Detects errors in Read/Write buffers on HDD cache RAM

Interface in F10 setup provides confirmation of SMART IV support.



Technical Specifications - Audio

High Definition Audio

Type Integrated

High Definition Stereo Codec Realtek 2-channel ALC261 codec

Front microphone-In (150-K ohm Input Impedance)

Rear Line-In (150-K ohm Input Impedance)

Audio I/O Ports Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)

Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load)

Internal Speaker Amplifier is for the internal speaker only. External speakers need to be powered externally. Rear Line-In audio port is re-task able as Line-In or Microphone-In.

Multistreaming Capable Multistreaming can be enabled in the Realtek control panel to allow independent audio streams to

be sent to/from the front and rear jacks.

8 kHz - 192 kHz Sampling

Wavetable Syntheses (software) Yes – Uses OS soft wavetable

1.5 W

Analog Audio

of Channels on Line-Out

Stereo (Left & Right channels)

(mono/stereo)

Internal Audio Speaker Power

Rating

Internal Speaker Yes External Speaker Jack Yes

(Line-Out)

HP Thin USB Powered Speakers

On/Off/Volume Controls Right side of right speaker Power LED Front of right speaker (green)

Frequency Response FO to 20kHz

Watts 2/3 watt (normal/maximum)

Dimensions/Speaker 5.72 x 3.74 x 0.96 in 14.52 x 9.50 x 2.45 cm $(H \times W \times D)$

0.68 lbs Net Weight 0.31 kg

Color Black

Operating Temperature: $\frac{14^{\circ} \text{ to } 104^{\circ} \text{ F}}{-10^{\circ} \text{ to } 40^{\circ} \text{ C}}$ Environmental (all conditions non-condensing)

Relative Humidity 40% to 90%

Input Cord: 5.91 ft 1800mm

L-channel Cord: 3.28 ft 1000mm Speaker Cable Length

USB Cord: 5.91 ft 1800mm



Technical Specifications - Communications

Intel® 82567V GbE Network Connection (integrated)

Connector **RJ-45**

Controller Intel® 82567V Gigabit platform LAN Connect Networking Controller

Memory 24 KB FIFO packet buffer memory

10/100/1000 Mbps Data rates supported

Compliance IEEE 802.3, 802.3ab and 802.3u compliant

Bus architecture GLCI, LCI interface. Intel specific MAC to PHY interface

At gigabit GLCI (Intel proprietary 802.3 series-based interface) is for Data, LCI (parallel bus) for Data transfer mode

MDIO, at 10/100 LCI for both data and MDIO, GLCI is idle.

Data rates supported 10/100/1000 Mbps

Hardware certifications FCC B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union

Requires 3.3V, 1.9/1.8V and 1.0V or just 3.3V with integrated regulators Power requirement

Power consumption 1.3 Watts for 82567 whole LOM

Boot ROM support Yes

Full-duplex

Network transfer mode Half-duplex (not supported for the 1000BASE-T transceiver)

> 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps

Network transfer rate 100BASE-TX (half-duplex) 100 Mbps

> 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating temperature $\frac{32^{\circ}}{70^{\circ}}$ to 131° F (0° to 55° C) To 70° C for external regulator Environmental

Operating Humidity: 85% at 131° F (55° C)

Management WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic.

HP Wireless Network Connection 802.11 b/g/n

 3.3×4.7 in Dimensions (L x H)

8.5 x 12 cm

0.08 lbs Weight

40 g

Controller Ralink RT2790 System interface PCIExpress x1 Network standard 802.11 b/g/n 2.400 - 2.497 GHz Frequency band

Operating temperature 14° to 149°F, operating (-10° to 65°C, operating)

-40° to 176°F, non-operating (-40° to 80°C, non-operating) Storage temperature

10-90% operating Humidity

5-95% non-operating

3.3V +/- 9% Operating voltage 12V +/- 8%



Technical Specifications - Communications

| , | Platform/WLAN Mode | Power Consumption | | | |
|--|--|--|-----------------|--|--|
| | Maximum Power Consumption | 10 Watts | | | |
| | Transmit Only | 4 Watts maximum averaged power over 1 second | | | |
| | Transmit Packet or Active Scanning | 1000 mA peak current for 100 microsed | conds or longer | | |
| Power consumption | Receive Only Mode or Idle without IEEE PSP mode enabled | 3 Watts maximum averaged over 1 second | | | |
| Tower concempnent | ldle, with IEEE PSP mode enabled | 1.0 Watts maximum averaged over 1 second | | | |
| | Transmit Disabled (turned off in software) | 50 mW maximum, averaged over 1 sec | ond | | |
| | Platform in S3 or S4 (power removed from Low Profile PCI Express Card) | 5 mW maximum, averaged over 1 seco | nd | | |
| | 802.11b mode | +19 dBm +/- 1.0 dB maximum | | | |
| Output power (approximately) | 802.11g mode | +17 dBm +/- 1.0 dB maximum | | | |
| Colput power (approximately) | EWC mode | +17 dBm +/- 1.0 dB maximum (total power in all tra | | | |
| | Mode | Data rate | Sensitivity | | |
| | 802.11b | 1 Mbps | -94 dBm | | |
| | 802.11b | 11 Mbps | -85 dBm | | |
| | 802.11g | 6 Mbps | -91 dBm | | |
| | 802.11g | 18 Mbps | -85 dBm | | |
| | 802.11g | 48 Mbps | -75 dBm | | |
| Receive Sensitivity | 802.11g | 54 Mbps | -72 dBm | | |
| | EWC (2.4 GHz) | 6.5 Mbps | -87 dBm | | |
| | EWC (2.4 GHz) | 54 Mbps | -82 dBm | | |
| | EWC (2.4 GHz) | 81 Mbps | -78 dBm | | |
| | EWC (2.4 GHz) | 162 Mbps | -74 dBm | | |
| | EWC (2.4 GHz) | 270 Mbps | -68 dBm | | |
| | EWC (2.4 GHz) | 300 Mbps | -64 dBm | | |
| | Data Rate (MCS) | Minimum Through | nput | | |
| | 1 Mbps (802.11 b) | 700 kbps | | | |
| | 2 Mbps (802.11 b) | 1.4 Mbps | | | |
| | 5.5 Mbps (802.11 b) | 3.5 Mbps | | | |
| 11 Mbps (802.11 b) 12 Mbps (802.11 g) | | 5.9 Mbps | | | |
| | | 6 Mbps | | | |
| | 18 Mbps (802.11 g) | 9 Mbps | | | |
| | 24 Mbps (802.11 g) | 12 Mbps | | | |
| | 36 Mbps (802.11 g) | 18 Mbps | | | |
| | 48 Mbps (802.11 g) | 21 Mbps | | | |
| | 54 Mbps (802.11 g) | 22.5 Mbps | | | |
| 18 | 6.5 Mbps (20 MHz EWC) | 4.5 Mbps | | | |



Technical Specifications - Communications

| | 13 Mbps (20 MHz EWC) | 9 Mbps |
|--------------------|---|-----------|
| | 19.5 Mbps (20 MHz EWC) | 13.5 Mbps |
| | 26 Mbps (20 MHz EWC) | 18 Mbps |
| Data transfer rate | 39 Mbps (20 MHz EWC) | 27 Mbps |
| | 52 Mbps (20 MHz EWC) | 36 Mbps |
| | 58.5 Mbps (20 MHz EWC) | 40 Mbps |
| | 65 Mbps (20 MHz EWC) | 45 Mbps |
| | 78 Mbps (20 MHz EWC) | 54 Mbps |
| | 104 Mbps (20 MHz EWC) | 72 Mbps |
| | 117 Mbps (20 MHz EWC) | 81 Mbps |
| | 130 Mbps (20 MHz EWC) | 91 Mbps |
| | 13.5 Mbps (40 MHz EWC) | 8 Mbps |
| | 27 Mbps (40 MHz EWC) | 16 Mbps |
| | 40.5 Mbps (40 MHz EWC) | 24 Mbps |
| | 54 Mbps (40 MHz EWC) | 32 Mbps |
| | 81 Mbps (40 MHz EWC) | 48 Mbps |
| | 108 Mbps (40 MHz EWC) | 64 Mbps |
| | 121.5 Mbps (40 MHz EWC) | 72 Mbps |
| | 135 Mbps (40 MHz EWC) | 81 Mbps |
| | IEEE and WiEi compliant 64 / 128 hit WEP encryption | |

IEEE and WiFi compliant 64 / 128 bit WEP encryption

AES: CCM

802.1x authentication

Security WPA: 802.1x. WPA-PSK and TKIP

WPA2 certification IEEE 802.11i

Cisco Certified Extensions, all versions through V5

Antenna HP part number 497792-001

Certifications Wi-Fi certified

Certifications for use by country United States, Canada, Peru, Taiwan



Technical Specifications - Graphics

Intel® Graphics Media Accelerator (GMA) 4500

3D/2D Controller Microsoft DirectX® 10 based with support for Pixel Shader 3.0

VGA Controller Integrated

DisplayPort Integrated, Multimode capable; supports HDCP

Bus Type PCI Express x16
RAMDAC Integrated, 350 MHz

Graphics memory is shared with system memory. Graphics memory usage varies depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is preallocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Memory

Assumes Management Engine, VT-d enabled and other memory allocated for other BIOS usage

| System Memory | PVAP | Avail System Memory (MB) | Total Avail GFX Memory (MB) | Dedicated Video Memory (MB) | | Shared System Memory (MB) |
|------------------|------|-----------------------------|-----------------------------------|-----------------------------------|----|------------------------------|
| 1 GB | Lite | 952 | 252 | 32 | 96 | 124 |
| 2 GB | Lite | 1976 | 764 | 32 | 96 | 636 |
| 4 GB | Lite | 4024 | 1759 | 32 | 96 | 1631 |
| 6 GB | Lite | 6072 | 1759 | 32 | 96 | 1631 |
| 8 GB | Lite | 8120 | 1759 | 32 | 96 | 1631 |

HW Video Decode

Hardware Accelerated decode for MPEG2 encrypted video; support for PAVP Lite (default)

Maximum Color Depth

32 bits/pixel

Maximum Vertical Refresh Rate

85 Hz at up to 1920x1440, 75 Hz at 2048x1536. Varies with mode and configuration. See table below.

Multi-display Support

Integrated dual independent monitor support facilitated via one VGA and one single link DVI-D port integrated on the back plane of the system board and presented as part of the rear I/O set of interfaces.

Maximum Refresh Rate (Hz)

Graphics/Video API Support

Microsoft DirectX® 10, OpenGL® 1.5 (OpenGL® 2.0 available in a driver update)

| | | | \ <i>\</i> |
|-----------------------|------------|--------------------------|--------------------|
| Resolutions Supported | Resolution | Analog Connection | Digital Connection |
| | 640x480 | 85 | 60 |
| | 800x600 | 85 | 60 |
| | 1024x768 | 85 | 60 |
| | 1280x720 | 85 | 60 |
| | 1280x1024 | 85 | 60 |
| | 1440x900 | 75 | 60 |
| | 1600x1200 | 85 | 60 |
| | 1680x1050 | 75 | 60 |
| | 1920x1080 | 85 | 60-R |
| | 1920x1200 | 85 | 60-R |



Technical Specifications - Graphics

1920x1440 85 N/A 2048x1536 75 N/A

Note:

Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Note:

60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections

ATI Radeon HD 4550 (512 MB DH) PCle x16 Graphics Card

Bus type PCI Express x16

Maximum vertical refresh rate 85 Hz

Display support Integrated 400 MHz RAMDAC

Display max resolution 1900 x 1200 digital, 2048 x 1536 analog

Supports two displays via included DMS-59 to dual VGA cable or 2 DVI monitors via optional

Board display options DMS-59 to dual DVI cable kit part number: DL139A. 4-pin mini-DIN S-video connector for TV

output

Specification Description

Graphics Chip RV710

Board configuration Core clock 600 MHz

Memory clock 800 MHz

Frame buffer 512 MB DDR3, 64 bit wide

24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian,

Languages supported Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean,

Norwegian, Polish, Portuguese, Russian, Spanish, Swedish, Thai, Turkish



^{*} Only supported when using a DisplayPort connection

Technical Specifications - Graphics

| _ | 4 | _ | _ | | ٠ | | ٠ | | | |
|----|---|----|---|---|---|----|---|---|---|---|
| F١ | M | ι. | г | m | ı | SS | 1 | റ | n | s |

FCC Part 15, Subpart B – Unintentional Radiators, Class B Computing Devices for Home & Office Use

CISPR22: 1997/EN 55022:1998 – Class B – Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment

Canadian Standard ICES-003 is equivalent to CISPR22

Taiwanese Standard BSMI

Japanese VCCI

Australian C-Tick

Korean (MIC)

EMC Immunity

CISPR 24:1997/EN 55024:1998 – Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement

Resolutions Supported

Compliance standards

Maximum Refresh Rate (Hz)

| Resolution | Analog Connection | Digital Connection |
|------------|-------------------|--------------------|
| 640x480 | 85 | 60 |
| 800x600 | 85 | 60 |
| 1024x768 | 85 | 60 |
| 1280x720 | 85 | 60 |
| 1280x1024 | 85 | 60 |
| 1440x900 | 75 | 60 |
| 1600x1200 | 85 | 60 |
| 1680x1050 | 75 | 60 |
| 1920x1080 | 85 | 60-R |
| 1920x1200 | 85 | 60-R |
| 1920x1440 | 85 | N/A |
| 2048x1536 | 75 | N/A |
| 2560x1600 | N/A | N/A |

Note:

Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Note:

60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections



Technical Specifications - Hard Drives

Introduction:

HP Serial ATA Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

Serial ATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, Serial Advanced Technology Attachment (SATA) interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology is allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing, is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), that allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver.

NOTE: GB = 1 billion bytes. Actual available capacity is less.



Technical Specifications - Hard Drives

HP 250-GB 3.5" Hard Disk Drive

Capacity 250,059,350,016 bytes

Rotational Speed 7,200 rpm **Interface** Serial ATA (SATA)

Synchronous Transfer Rate Up to 3 GB/s (limited by the system SATA controller)

(Maximum)

Buffer Size 8 MB

Logical Blocks 488,397,168

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 1.0 ms

Average: 8.5 ms

Full-Stroke: 18 ms

Height (nominal) 1 in/2.54 cm

Width (nominal) Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications - Input/Output Devices

HP USB Standard Keyboard

Electrical

104, 105, 106, 107, 109 layout Keys

(depending upon country)

Physical 18.0 x 6.4 x 0.98 in Dimensions $(L \times W \times H)$ characteristics

45.8 x 16.3 x 2.5 cm

2 lb Weight 0.9 kg

Operating voltage + 5VDC \pm 5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

38 available Languages

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Switch type Contamination-resistant switch membrane

> Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 -2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

-22° to 140° F (-30° to 60° C) Non-operating temperature

10% to 90% (non-condensing at ambient) Operating humidity

Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

2-g peak acceleration Operating vibration Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Environmental

Technical Specifications - Input/Output Devices

UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC **Approvals**

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Keyboard Installation Guide Kit contents

Warranty Card Safety and Comfort Guide

HP PS/2 Standard Keyboard

104, 105, 106, 107, 109 layout Keys

(depending upon country)

Physical 18.0 x 6.4 x 0.98 in Dimensions (L \times W \times H) characteristics

45.8 x 16.3 x 2.5 cm

2 lb Weight 0.9 kg minimum

+ 5VDC \pm 5% Operating voltage

Power consumption 50-mA maximum (with three LEDs ON)

System interface PS/2 6-pin mini din connector

Electrical **ESD** CE level 4, 15-kV air discharge

> EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Languages 38 available

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Switch type Contamination-resistant switch membrane Mechanical

> Key-leveling mechanisms For all double-wide and greater-length keys

6 ft Cable length 1.8 m

Microsoft PC 99 -2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

50° to 122° F (10° to 50° C) Operating temperature

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Technical Specifications - Input/Output Devices

Operating shock 40 g, six surfaces Environmental

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Keyboard Installation Guide

Warranty Card Safety and Comfort Guide

HP USB Smart Card (CCID) Keyboard

Introduction:

Kit contents

Boost your security, simplify access procedures and reduce the costs associated with managing networks by preventing unauthorized access to your computers and networks using smartcard technology with the HP Smart Card (CCID) Keyboard.

The USB Smart Card (CCID) Keyboard is a full-sized keyboard that takes advantage of digital signatures and certificates to secure the environment for transactions performed on both public and private networks. The USB Smart Card (CCID) Keyboard works with all smart cards that comply with ISO standard 7816.

Smart cards are easy-to-use credit card-sized devices which require multiple forms of information to be validated before you gain access to your accounts or resources. Used worldwide, smart cards strengthen access to a network or other resource using dual-factor authentication. Implementing a two-factor authentication (or multi-factor authentication) process reduces the risk of unauthorized access by verifying and validating your identity in one of the following ways:

- Something you know a combination of username and password or PIN
- Something you have a smart card or security token.

Something you have (smart card) plus something you know (PIN), improves user-access security within corporate network environments. Smart cards are used in government agencies, healthcare companies and the finance industry.

HP ProtectTools Smart Card Manager provides authentication software for the smart card. The Smart Card Reader module works with the HP ProtectTools Security Manager and enables the user to setup, use, and manage the smart card. This allows strengthened security with HP patented technology.

- Protects against unauthorized access with smart card technology
- Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software
- Combination of username and password or pin with a smart card or security token
- Secures online transactions using digital signatures and certificates
- Conforms to industry standards for ease of setup and use
- Delivers long product life and quiet operation with high-impact materials and lubricated keys



Key Benefits:

characteristics

Electrical

Technical Specifications - Input/Output Devices

• Spill drain feature

104, 105, 106, 107, 109 layout Keys

(depending upon country)

Form factor USB basic smart card keyboard

Physical Colors Carbonite/Silver

> 18.2 x 6.3 x 1.3 in Dimensions $(L \times W \times H)$ 46.3 x 16.1 x 3.3 cm

2 lb Weight

0.9 kg minimum

+ 5VDC \pm 5% Operating voltage

100-mA maximum (with four LEDs ON) Power consumption

USB Type A plug connector System interface

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

30+ available Languages

Standard design Keycaps

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Switch type Contamination-resistant switch membrane Mechanical

> Key-leveling mechanisms For all double-wide and greater-length keys

6 ft Cable length 1.8 m

Microsoft PC 99 -2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

-22° to 140° F (-30° to 60° C) Non-operating temperature

10% to 90% (non-condensing at ambient) Operating humidity

Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-a peak acceleration



Environmental

Technical Specifications - Input/Output Devices

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4 memory and

microprocessor smart cards (T=0, T=1)

Chipset SCM STCIII

Standard APIs supported PC/SC, EMV2000, CT-API

USB Port

Short circuit detection (protects smart card and reader)

Power

Power supply compliant with ISO7816 and EMV (5V, 60 mA)

Supports 3-V and 5-V cards

SmartCard Function Power consumption 100-mA maximum draw

From card 9600 bps to 330,000 bps

Communication
From computer 12 Mbps (USB transfer speed)

Contact device Friction contact

Landing mechanism

Card insertions rating Up to 100,000 insertion cycles

Interface modes CCID protocol

Reader performance interface USB connection

Europe 2004/108/EC

Electro-magnetic standards

USA

USAFCC part 15

Approvals CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF

Ergonomic compliance ISO 9241-4, TUVGS

Kit Contents Keyboard, I/O Security and Documentation CD, warranty card

HP ProtectTools Smart Card

American Express Amex Blue

Cryptoflex 8K Cryptoflex 16K Cryptoflex 32K Cryptoflex 32K e

Cryptoflex 32K e-gate Cyberflex Access 64K Cyberflex Access 32K Cyberflex 32K e-gate Cyberflex 64K

Cyberflex Palmera

Axalto (Schlumberger)

Payflex-S

Payflex 1K



Smart Card Compatibility

Technical Specifications - Input/Output Devices

Payflex 2K Payflex 4K Payflex 8K Prismera US DoD CAC PrimeFlex Store 8K PrimeFlex Store 2K

Cardlogix CLXSU004KK4
CLXSU008KK5

Safenet, Inc.

Model 300

Model 330

De-La Rue VisaCash

Gem Expresso GKK32K

Gemplus Gemclub Memo

GemClub Micro GemXplore GemSafe

SLE66C322P SLE4406 SLE4406E SLE4406E SE

 Infineon
 SLE4418

 SLE4428

SLE4432 SLE4436E SLE4442 SLE5536

SafLink (Litronic) Forte

Shart Java Card

CosmopolIIC v4.1

Oberthur Cosmo ID-One GalatIIC v2.1

US DoD CAC

Memory Cards

AT24C01ASC AT24C02SC AT24C04SC AT24C08SC AT24C16SC

Atmel AT24C32SC

AT24C64SC AT24C128SC AT24C256SC

Technical Specifications - Input/Output Devices

AT24C512SC AT88SC153 AT88SC1608

ST 14C02

Telefonkarte SLE4406

SLE5536

XICOR X24026

HP USB/PS2 Washable Keyboard

The HP USB PS2 Washable Keyboard is well-suited for environments that require keyboards to be immersed and cleaned with the following solvents: soap, washing-up liquid, non-abrasive cleaners, general purpose cleaners, bleach, disinfectant, antibacterial cleaners and surgical spirit. The HP USB PS2 Washable Keyboard provides protection against ingress of water and dust to code IP66 defined in IEC (International Electro Technical Commission) standard 60529-1 and code 4X as defined in NEMA (National Electrical Manufacturers Association) standard 250. The code IP66 defined in the IEC standard 60529 means the keyboard is protected against the ingress of dust, and that high pressure water jets from any direction will not have any harmful effects. A NEMA 4X enclosure as defined in NEMA standard 250 will provide protection against windblown dust, rain, splashing water and hose directed water. For additional information on regulatory standards consult your legal department.

NOTE: Observe the manufacturer's instructions for the preparation and use of all cleaning fluids and wear the appropriate protective clothing.

WARNING: To reduce the risk of electric shock, avoid using the keyboard with a computer in wet locations.

- SpillSeal® keyboard technology protection; provides protection from liquids and dust as defined in IEC standard 60529-1, code IP66, and NEMA standard 250, code 4X
- Sealed structure able to be fully washed under running water (If the USB plug [connector] gets wet, shake dry before reconnecting.)
- Waterproof exterior that protects against windblown dust, rain, splashing water and hosedirected water
- USB extension cable allows the keyboard to be easily disconnected without having to access the computer
- Plug and play capability when using supported Microsoft Windows operating systems. No additional software drivers are required
- USB or PS2 connection
- User selectable, zero degree slope for potential wrist posture improvement and associated usage comfort
- Key mechanism lifecycle rated at 10 million keystrokes

The HP USB/PS2 Washable Keyboard is compatible with all HP Compag Business PCs

Your Option Limited Warranty is a one (1) year (HP Option Limited Warranty Period) parts replacement warranty on any HP-branded or Compaq-branded options (HP Options). If your HP Option is installed in an HP Hardware Product, HP may provide warranty service either for the HP Option Limited Warranty Period or the remaining Limited Warranty Period of the HP Hardware Product in which the HP Option is being installed, whichever period is the longer but not to

Key Benefits:

Compatibility

Service and Support



Technical Specifications - Input/Output Devices

exceed three (3) years from the date you purchased the HP Option.

Keys 104 (US) layout or 105 (EU) layout

(depending upon country)

Weight 1.7 lb

0.77 kg minimum

Operating voltage $+ 5VDC \pm 5\%$

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI – RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 – 2001 Functionally compliant

Keycaps Stepped profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 7 ft 2.2 m

Microsoft PC 99 –2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 95% (non-condensing at ambient)

Non-operating humidity 0% to 95% (non-condensing at ambient)

Environmental Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1,

IP66/NEMA4X



Approvals

Electrical

Technical Specifications - Input/Output Devices

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Keyboard with USB cable, USB-to_PS2 adapter, Quick disconnect cable with extension to

lengthen your cable, I/O Security Software & Documentation CD including the safety and comfort

guide, warranty card

HP PS/2 Optical Mouse

Kit Contents

Environmental

Dimensions 1.56 x 2.44 x 4.61 in (H x L x W) 3.95 x 6.21 x 11.7 cm

Weight 4.44 oz 126 g

Operating temperature $\begin{array}{c} -32^{\circ} \text{ to } 104^{\circ}\text{F} \\ 0^{\circ} \text{ to } 40^{\circ} \text{ C} \end{array}$

Non-operating temperature $\begin{array}{c} -4^{\circ} \text{ to } 140^{\circ}\text{F} \\ -20^{\circ} \text{ to } 60^{\circ} \text{ C} \end{array}$

Operating humidity 10% to 90%

(non condensing at ambient)

Non-operating humidity 10% to 90%

(non condensing at ambient)

Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration

Non-operating vibration 4 g peak acceleration

Drop (out of box)

80 cm height onto asphalt tile over concrete or equivalent, 5-drop

in 5 direction except the cable face

Operating voltage 5 VDC \pm 10%

Power consumption 100mA

System consumption PS/2 mini-din connector

ESD CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft PC99 - 2001 Functionally compliant

Resolution 400 \pm 20% DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

Acceleration 100 in/s/s (2.54 m/s/s)

Switch actuation 61 g nominal peak force

Mechanical Switch life 3,000,000 operations (using Hasco modified tester)

Electrical

Technical Specifications - Input/Output Devices

Switch type Low force micro-switches

Tracking mechanism life 155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Width 8 mm

Diameter 1.01 in (25.6 mm)

Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch

Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

HP USB Optical Mouse

Scroll wheel

Dimensions 1.5 x 4.5 x 2.5 in (H x L x W) 3.8 x 11.6 x 6.3 cm

Weight 0.27 lb 0.12 kg

Cable length 72.8 in 185 cm

System requirements

Microsoft Windows 95, 98, 2000, Me, XP and Vista

Available USB port

HP USB Laser Mouse

Scroll Wheel 24

Maximum Rotation Speed 48 rats/sec

Switch Type wheel

Switch Life Button – 3,000,000

Wheel -1,000,000 times Tilt switch -500,000 times

Environmental Operating Temperature 32° to 104° F

 0° to 40° C

Non-operating Temperature -4° to 140° F

 -20° to 60° C



Technical Specifications - Input/Output Devices

10% to 90% **Operating Humidity**

(non-condensing at ambient)

Non-operating Humidity 20% to 80%

(non-condensing at ambient)

Operating Shock 40 g, six surfaces

Non-operating Shock 80 g, six surfaces

Operating Vibration 2-g peak acceleration

Non-operating Vibration 4-a peak acceleration

Electrical Operating Voltage + 5VDC \pm 5%

Power Consumption

MTBF > 150,000 hrs

ESD IEC-61000-4-2 criteria B, Contact discharge: +/- 4kV, Air

discharge: +/- 8kV

EMI-RFI FCC Class B

PC98 PC 99 Compliant

Mechanical Resolution 800dpi

> Tracking Speed 25 cm/sec

0.5mm Acceleration

Switch Actuation 0.6N (60af)

Switch Life Button -3,000,000

> Wheel - 1,000,000 times Tilt switch - 500,000 times

Cable Length 1850mm

PC98-99 PC99 compliant

UL60950-1, UL 94, UL 746 (A-E), UL 796 Regulatory Approvals

TUV/GS: EN 60950-1, EN 60825-1

FCC Class B, UL 1950, cUL, TUV GS, CE, C-tick, VCCI, BSMI, RRL

HP USB/PS2 Washable Mouse

The HP USB PS2 Washable Mouse is a USB based mouse that is designed to be taken apart (disassembled), when it becomes soiled, or in the event that something is spilled on it. The mouse can to be immersed for cleaning with the following solvents: soap, washing-up liquid, non-abrasive cleaners, general purpose cleaners, bleach, disinfectant, antibacterial cleaners and surgical spirit. The HP USB PS2 Washable Mouse provides protection against ingress of water and dust to code IP66 defined in IEC (International Electro Technical Commission) standard 60529-1 and code 4X as defined in NEMA (National Electrical Manufacturers Association) standard 250. The code IP66 defined in the IEC standard 60529 means the mouse is protected against the ingress of dust, and that high pressure water jets from any direction will not have any harmful effects. A NEMA 4X enclosure as defined in NEMA standard 250 will provide protection against windblown dust, rain, splashing water and hose directed water. For additional



Key Benefits:

Service and Support

Physical characteristics

Electrical

Technical Specifications - Input/Output Devices

information on regulatory standards consult your legal department.

NOTE: Observe the manufacturer's instructions for the preparation and use of all cleaning fluids and wear the appropriate protective clothing.

WARNING: To reduce the risk of electric shock, avoid using the keyboard with a computer in wet locations.

- Sealed structure able to be fully washed under running water
- Waterproof exterior that protects against windblown dust, rain, splashing water, hose-directed water, and damage from external ice formation
- Removable scroll wheel that clips back into place after cleaning
- SpillSeal® mouse technology protection, which provides protection from liquids and dust as defined in IEC standard 60529-1, code IP66, and NEMA standard 250, code 4X
- Plug and play capability when using supported Microsoft Windows operating systems. No additional software drivers are required
- USB or PS2 connection
- Optical tracking with two standard buttons and a third button located in the center for highlighting information or autoscrolling

Compatibility The HP USB/PS2 Washable Mouse is compatible with all HP Compaq Business PCs

Your Option Limited Warranty is a one (1) year (HP Option Limited Warranty Period) parts replacement warranty on any HP-branded or Compaq-branded options (HP Options). If your HP Option is installed in an HP Hardware Product, HP may provide warranty service either for the HP Option Limited Warranty Period or the remaining Limited Warranty Period of the HP Hardware Product in which the HP Option is being installed, whichever period is the longer but not to exceed three (3) years from the date you purchased the HP Option.

D: 1.56 x 2.44 x 4.61 in

Dimensions (H x L x W) 3.95 x 6.21 x 11.7 cm

Weight 4.44 oz 126g

Operating voltage 5VDC $\pm 10\%$

Power consumption 100mA

System interface PS/2 mini-din connector or USBr

ESD CE level 2 8 kV air discharge

EMI – RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 – 2001 Functionally compliant

Resolution $1000 \pm 20\% \text{ DPI}$

Tracking speed 14 in/s (35.56 cm/s) maximum

Acceleration 2g

Switch actuation 70g nominal peak force

Mechanical Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches



Technical Specifications - Input/Output Devices

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 8.8 ft total 70 cm + 2m extension

Microsoft PC 99 –2001 Mechanically compliant

Operating temperature -32° to 104° F (0° to 40° C)

Non-operating temperature -4° to 140° F (-20° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 10% to 90% non-condensing

Environmental Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box)

80 cm height onto asphalt tile over concrete or equivalent, 5-

drop in 5 direction except the cable face

Width 6mm

Diameter 1 in (25.4 mm)

Maximum Rotation speed 48 rats/sec

Switch type Light force micro-switch

Switch life 3 million operations

Mechanical life Minimum 200,000 revolutions

Approvals FCC, CE Mark, ICES-003-B, IP66/NEMA4X

Windows Vista Business 64, Windows Vista Business 32, Windows Vista Home Basic 32,

Compatibility Windows 2000, Windows XP Professional or Windows XP Home 32 (No driver is required for this

device. Native support is provided by the operating system.), xpe, ce.net, Linux, XP-64



Scroll Wheel

Technical Specifications - Optical Storage

HP Blu-ray Writer

Height 5.25-inch, half-height, tray-load

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity 50 GB DL or 25 GB standard

Dimensions (W x H x D) $14.8 \times 4.2 \times 18.0 \text{ (max) cm}$

Weight (max) 2.1 lb 950 g

| | | Single-layer | Double-layer |
|-------------------|---------|----------------------------------|-------------------------------|
| | BD-R | 2x, 4x CLV, 6x | 2x, 4x CLV, 6X PCAV or ZCLV |
| | BD-RE | 2x CLV | 2x CLV |
| | DVD-R | 4x CLV, 8x, 12x PCAV, 16x CAV | 4x CLV, 8X PCAV or ZCLV |
| | DVD-RW | 2x, 4x CLV, 6x CLV or ZCLV | Not supported |
| Write speed (max) | DVD+R | 4x CLV, 8x, 12x PCAV, 16x CAV | 2.4x, 4x CLV, 8X PCAV or ZCLV |
| | DVD+RW | 2.4x, 4x, 6x CLV, 8x ZCLV | Not supported |
| | DVD-RAM | 2x, 3x CLV, 5x PCAV or CLV | |

CD-R 16x CLV, 24x, 32x PCAV, 40x CAV or PCAV

CD-RW 4x, 10x, 16x CLV, 24x ZCLV

| | Single-layer | Double-layer |
|----------------------------|------------------------|--------------|
| BD-ROM | 8x CAV | 8x CAV |
| BD-R | 8x CAV | 8x CAV |
| BD-RE | 6x CAV | 6x CAV |
| DVD-ROM | 16x CAV | 8x CAV |
| DVD-R | 12x CAV | 8x CAV |
| DVD-RW | 10x CAV | Not support |
| DVD+R | 12x CAV | 8x CAV |
| DVD+RW | 10x CAV | Not support |
| BDMV (AACS Compliant Disc) | 2x CLV, 4.8x or 6x CAV | |

2x, 3x CLV, 5x PCAV or CLV



Read speeds

DVD-RAM

Technical Specifications - Optical Storage

DVD-Video (CSS Compliant

Disc)

8x CAV

CD-R/RW/ROM 40x / 40x / 40x CAV

CD-DA (DAE) 32x CAV

80 mm CD 16x CAV

BD-ROM 26.97 MB/s (6x) max

Sustained Transfer rate DVD-ROM 21.6 MB/s (16x) max.

> CD-ROM 6,000 KB/s (40x) max.

1.5Gbps bits/s (10b side) **Burst Transfer rate**

1.2Gbps bits/s (8b side)

Multimedia MPC-3 compliant

DVD-ROM: < 150 ms (typical),Random

CD-ROM: < 140 ms (typical)

(typical reads, including setting)

Full Stroke

DVD-ROM: < 240 ms (typical), CD-ROM: < 230 ms (typical)

Source SATA DC power receptacle

DC Power Requirement Power

 $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$ $12 \text{ VDC} \pm 10\%-100 \text{ mV ripple p-p}$

5 VDC -1200 mA typical, 1500 mA maximum DC Current 12 VDC -1000 mA typical, 1500 mA maximum

10% to 90%

Temperature (operating) 41° to 122° F (5° to 50° C)

Environmental

Access times

(all conditions non-condensing) Relative Humidity (operating)

Maximum Wet Bulb

86° F (30° C) Temperature (operating)

HP SuperMulti DVD Writer Drive

5.25-inch, half-height, tray-load Height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity 8.5 GB DL or 4.7 GB standard

 $5.8 \times 1.7 \times 6.9$ (max) in Dimensions ($W \times H \times D$)

 $14.8 \times 4.2 \times 17.5 \text{ (max) cm}$

Weight (max) 2.1 lb

950g

DVD-RAM Write speeds (max) Up to 12X



| Technical | Specifications - | Optical | Storage |
|-----------------|------------------|---------|---------|
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| - Oplical Slorage | |
|--------------------------|--|
| DVD+R | Up to 16X |
| DVD+RW | Up to 8X |
| DVD+R DL | Up to 12X |
| DVD-R DL | Up to 12X |
| DVD-R | Up to 16X |
| DVD-RW | Up to 6X |
| CD-R | Up to 40X |
| CD-RW | Up to 32X |
| DVD-RAM | Up to 12X |
| DVD+RW, DVD-RW | Up to 8X |
| DVD+R DL, DVD-R DL | Up to 12X |
| DVD-ROM DL | Up to 8X |
| DVD-ROM, DVD+R, DVD-R | Up to 16X |
| CD-ROM, CD-R | Up to 40X |
| CD-RW | Up to 32X |
| Random | DVD-ROM: < 130 ms (typical), CD-ROM: < 120 ms (typical) |
| Full Stroke | DVD-ROM: < 240 ms (typical), |

Access time

(typical reads, including

Read speeds (max)

settling)

CD-ROM: < 200 ms (typical)

Power Source SATA DC power receptacle

> DC Power Requirement $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$

> > $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

12 VDC (< 1200 mA typical, 2000 mA maximum)

Environmental conditions

(operating - non-condensing)

Temperature

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 90%

Maximum Wet Bulb

Temperature

86° F (30° C)

HP DVD-ROM

5.25-inch, half-height, tray-load Height

Orientation Either horizontal or vertical



Technical Specifications - Optical Storage

Interface type SATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

Dimensions (W x H x D) $5.8 \times 1.7 \times 6.9$ (max) in

 $14.8 \times 4.2 \times 17.5$ (max) cm

Weight (max) 2.1 lb

950 g

Read speeds (max) DVD+RW/-RW/+R DL /-R DL

/-ROM DL

Up to 8X

DVD-ROM Up to 16X

DVD-RAM Up to 12X

CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

Removable Storage – Media Compatibility – DVD-ROM

(typical reads, including setting)

Media

Read

Write

CD-ROM Yes No

CD-R Yes No

CD-RW Yes No

DVD-ROM Yes No

DVD-ROM DL Yes No

DVD-RAM Yes No

DVD+R Yes No

DVD+R DL Yes No

DVD+RW Yes No

DVD-R Yes No

DVD-R DL Yes No.

Access times Random DVD-ROM: < 130 ms

(typical),

CD-ROM: < 120 ms

(typical)

Full Stroke DVD-ROM: < 240 ms

(typical),

CD-ROM: < 200 ms

(typical)

Cache Buffer 198 KB (minimum)



Technical Specifications - Optical Storage

Data Transfer Modes ATA PIO mode 4 (16.7

MB/s); ATA Multi-word DMA mode 2 (16.7 MB/s); ATA UltraDMA Mode 5 (100 MB/s -

default)

Power Source SATA DC power

receptacle

DC Power Requirement 5 VDC ± 5%-100 mV

ripple p-p

12 VDC ± 5%-200 mV

ripple p-p

DC Current 5 VDC - <1000 mA

typical, < 1600 mA

maximum

12 VDC -< 1200 mA typical, < 2000 mA

maximum

Environmental

(all conditions non-condensing)

Temperature

41° to 122° F (5° to 50°

C)

Relative Humidity 10% to 90%

Maximum Wet Bulb

Temperature

86° F (30° C)



Technical Specifications - Removable Storage

HP 22-n-1 Media Card Reader

USB 2.0 High-speed interface

USB Interface Note:

Requires the USB cable to be connected to the internal USB 2.0 port or a USB 2.0 PCI card.

Two IEEE-1394a external ports; 1 IEEE-1394a internal port (connects to the pass through cable on the media card reader)

Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports MS 4-bit parallel transfer mode

Supports MS-PRO 4-bit parallel transfer mode

Advance protocol support

Supports MS PRO-HG Duo 4-bit parallel transfer mode

Supports SD 4-bit parallel transfer mode

Supports high-speed 50Mhz SD 4-bit card (version 2.0)

Supports high-speed 52Mhz MMC 8-bit card (version 4.2)

Supports CF v4.0 with PIO mode 6 and Ultra DMA mode

CompactFlash Type I

CompactFlash Type II

Microdrive

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMediaCard 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMediaCard 4.2 (MMC Mobile, including MMC Mobile HC)

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)

miniSD

miniSD High Capacity

Micro SD (T-Flash)

Micro SD HC

Memory Stick

Memory Stick Select

Memory Stick Duo (MS Duo)

Memory Stick PRO (MS PRO)



Supported media type

Technical Specifications - Removable Storage

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

MagicGate Memory Stick (MG)

MagicGate Memory Stick Duo

xD-Picture Card

Supported media type with card adapter

Environmental

Memory Stick Micro (M2)

MMC Micro

Test Parameters/Conditions - Power applied, unit operating on

system ±5%

nominal supply voltage.

10°C 10% R.H. = 24 hours

Operational Environmental

Extremes

 10° C 90% R.H. = 24 hours 20°C 90% R.H. = 24 hours

30°C 90% R.H. = 24 hours 40°C 90% R.H. = 24 hours 50°C 90% R.H. = 24 hours 50°C 10% R.H. = 24 hours

Test Parameters/Conditions

140°F (60°C) @ 80% R.H. for 96 hours -22°F (-30°C) @ 20% R.H. for 48 hours

Storage Environmental

Extremes

No power applied

Delta °C < 1.0°C/min Delta % R.H. < 1.5% R.H./min

USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev.

1.0

Approvals

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3

FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUV-T



Technical Specifications - Environmental Data

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US ENERGY STAR
- IT ECO declaration
- EPEAT Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.

| Energy Consumption | 115 VAC | 230 VAC | 100 VAC |
|---------------------------------------|--------------|-------------|-------------|
| Normal Operation | 26.963 W | 26.813 W | 26.988 W |
| Sleep (Energy Star low power mode) | 2.529 W | 2.706 W | 2.513 W |
| Off | 1.347 W | 1.507W | 1.328 W |
| Heat Dissipation* | 115 VAC | 230 VAC | 100 VAC |
| Normal Operation | 92.21 BTU/hr | 92 BTU/hr | 92.2 BTU/hr |
| Sleep | 9 BTU/hr | 9.25 BTU/hr | 8.5 BTU/hr |
| Off | 5 BTU/hr | 5.15 BTU/hr | 4.5 BTU/hr |

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

| System Fan Off | Sound Power (LWAd, bels) | Sound Pressure (LpAm, decibels) |
|-------------------------------|-----------------------------|------------------------------------|
| Idle | 3.84 | 28.2 |
| Fixed Disk (random writes) | 4.31 | 32.3 |

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional formation

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.



Technical Specifications - Environmental Data

- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% post consumer recycled plastic (by wt.)
- This product is 93.8% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - O Corrugated 1966 g
- Internal:
 - O Polyethylene low density foam 154 g
- The Polyethylene low density foam packaging material is made from 100% recycled content.
- The Corrugated Packaging materials contains at least 49% recycled content.

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)



Technical Specifications - Environmental Data

 Nickel finishes that release greater than 0.5 micro-grams/cm²/week, measured according to EN 1811:1998, are not used on any product surface designed to be frequently handled or touched by users.

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

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